
PART NUMBER**54HC160BEA-ROCV**

Rochester Electronics**Manufactured Components**

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All re-creations are done with the approval of the Original Component Manufacturer. (OCM)

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceeds the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-38535
 - Class Q Military
 - Class V Space Level

Qualified Suppliers List of Distributors (QSLD)

- Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OCM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

REVISIONS			
LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED
A	Add vendor CAGE 27014 to case outline 2. Add Clear input to truth table. Editorial changes throughout. Add vendor CAGE 01295 to case outline F.	87-04-10	Nelson A. Hauck
B	Correct the title. Correct the conditions for V _{OH} and V _{OL} tests in table I. Editorial changes throughout. - jak	12-02-02	Thomas M. Hess
C	Update boilerplate paragraphs to the current MIL-PRF-38535 requirements. - LTG	19-04-30	Thomas M. Hess

CURRENT CAGE CODE 67268



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REV STATUS		REV	C	C	C	C	C	C	C	C	C	C	C	C	C	C	C			
OF SHEETS		SHEET	1	2	3	4	5	6	7	8	9	10	11	12						
PMIC N/A		PREPARED BY Jeffery Tunstall				DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990 https://www.dla.mil/landandmaritime														
STANDARD MICROCIRCUIT DRAWING THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE AMSC N/A		CHECKED BY Dan DiCenzo																		
		APPROVED BY Nelson A. Hauck				MICROCIRCUIT, DIGITAL, HIGH SPEED CMOS, 4-BIT SYNCHRONOUS DECADE COUNTER, MONOLITHIC SILICON														
		DRAWING APPROVAL DATE 86-09-29																		
		REVISION LEVEL C				SIZE A	CAGE CODE 14933	5962-86824												
										SHEET 1 OF 12										

1. SCOPE

1.1 Scope. This drawing describes device requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A.

1.2 Part or Identifying Number (PIN). The complete PIN is as shown in the following example:

5962-86824	01	E	A
Drawing number	Device type (see 1.2.1)	Case outline (see 1.2.2)	Lead finish (see 1.2.3)

1.2.1 Device type(s). The device type(s) identify the circuit function as follows:

Device type	Generic number	Circuit function
01	54HC160	4-Bit synchronous decade counter

1.2.2 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	Terminals	Package style
E	GDIP1-T16 or CDIP2-T16	16	Dual-in-line
F	GDFP2-F16 or CDFP3-F16	16	Flat pack
2	CQCC1-N20	20	Square leadless chip carrier

1.2.3 Lead finish. The lead finish is as specified in MIL-PRF-38535, appendix A.

1.3 Absolute maximum ratings. 1/ 2/

Supply voltage range (V_{CC})	-0.5 V dc to +7.0 V dc
DC input voltage range (V_{IN})	-0.5 V dc to $V_{CC} + 0.5$ V dc
DC output voltage range (V_{OUT})	-0.5 V dc to $V_{CC} + 0.5$ V dc
Input clamp current (I_{IK})	± 20 mA
Output clamp current (I_{OK})	± 20 mA
DC output current (per pin)	± 25 mA
DC V_{CC} or GND current (per pin)	± 50 mA
Storage temperature range (T_{STG})	-65°C to +150°C
Maximum power dissipation (P_D)	500 mW <u>3/</u>
Lead temperature (soldering, 10 seconds)	+260°C
Thermal resistance, junction-to-case (θ_{JC})	See MIL-STD-1835
Junction temperature (T_J)	+175°C

1.4 Recommended operating conditions. 2/

Supply voltage range (V_{CC})	+2.0 V dc to +6.0 V dc
Case operating temperature range (T_C)	-55°C to +125°C
Input rise or fall time (t_r , t_f):	
$V_{CC} = 2.0$ V	0 to 1000 ns
$V_{CC} = 4.5$ V	0 to 500 ns
$V_{CC} = 6.0$ V	0 to 400 ns

1/ Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.

2/ Unless otherwise specified, all voltages are referenced to GND.

3/ For $T_C = +100^\circ\text{C}$ to +125°C, derate linearly at 12 mW/°C.

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2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard Microcircuits.

MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings.

MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at <https://quicksearch.dla.mil>).

2.2 Non-Government publications. The following document(s) form a part of this document to the extent specified herein. Unless otherwise specified, the issues of these documents cited in the solicitation or contract.

JEDEC – SOLID STATE TECHNOLOGY ASSOCIATION (JEDEC)

JESD7 - Standard for Description of 54/74HCXXXXX and 54/74HCTXXXXX Advanced High-Speed CMOS Devices.

(Copies of these documents are available online at <http://www.jedec.org> or from JEDEC – Solid State Technology Association, 3103 North 10th Street, Suite 240-S Arlington, VA 22201-2107).

2.3 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.

3.2.1 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.3 Truth table. The truth table shall be as specified on figure 2.

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3.2.4 Logic diagram. The logic diagram shall be as specified on figure 3.

3.2.5 Switching waveforms. The switching waveforms and test circuit shall be as specified in figure 4.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full case operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

3.5 Marking. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device.

3.5.1 Certification/compliance mark. A compliance indicator "C" shall be marked on all non-JAN devices built in compliance to MIL-PRF-38535, appendix A. The compliance indicator "C" shall be replaced with a "Q" or "QML" certification mark in accordance with MIL-PRF-38535 to identify when the QML flow option is used.

3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6 herein). The certificate of compliance submitted to DLA Land and Maritime -VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.

3.7 Certificate of conformance. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.8 Notification of change. Notification of change to DLA Land and Maritime -VA shall be required for any change that affects this drawing.

3.9 Verification and review. DLA Land and Maritime, DLA Land and Maritime's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

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TABLE I. Electrical performance characteristics.

Test	Symbol	Test conditions <u>1/</u> -55°C ≤ T _C ≤ +125°C unless otherwise specified	Group A subgroups	Limits		Unit
				Min	Max	
High level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL} I _{OH} = -20 μA	V _{CC} = 2.0 V	1, 2, 3	1.9	V
					4.4	
					5.9	
		V _{IN} = V _{IH} or V _{IL} I _{OH} = -4.0 mA	V _{CC} = 4.5 V	1, 2, 3	3.70	
		V _{IN} = V _{IH} or V _{IL} I _{OH} = -5.2 mA	V _{CC} = 6.0 V	1, 2, 3	5.20	
Low level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL} I _{OL} = +20 μA	V _{CC} = 2.0 V	1, 2, 3	0.1	V
			V _{CC} = 4.5 V		0.1	
			V _{CC} = 6.0 V		0.1	
		V _{IN} = V _{IH} or V _{IL} I _{OL} = +4.0 mA	V _{CC} = 4.5 V	1, 2, 3	0.4	
		V _{IN} = V _{IH} or V _{IL} I _{OL} = +5.2 mA	V _{CC} = 6.0 V	1, 2, 3	0.4	
High level input voltage	V _{IH} <u>2/</u>		V _{CC} = 2.0 V	1, 2, 3	1.5	V
			V _{CC} = 4.5 V		3.15	
			V _{CC} = 6.0 V		4.2	
Low level input voltage	V _{IL} <u>2/</u>		V _{CC} = 2.0 V	1, 2, 3	0.3	V
			V _{CC} = 4.5 V		0.9	
			V _{CC} = 6.0 V		1.2	
Input capacitance	C _{IN}	V _{IN} = 0.0 V T _C = +25°C See 4.4.1c	4		10.0	pF
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND V _{CC} = 6.0 V	1, 2, 3		160.0	μA
Input leakage current	I _{IN}	V _{CC} = 6.0 V V _{IN} = V _{CC} or GND	1, 2, 3		±1.0	μA
Functional tests		See 4.4.1b	7			
Propagation delay time, CLOCK to Q	t _{PHL1} , t _{PLH1} <u>3/</u>	T _C = +25°C C _L = 50 pF ±10% See figure 4	V _{CC} = 2.0 V	9	205	ns
			V _{CC} = 4.5 V		41	
			V _{CC} = 6.0 V		35	
		T _C = -55°C, +125°C C _L = 50 pF ±10% See figure 4	V _{CC} = 2.0 V	10, 11	310	ns
			V _{CC} = 4.5 V		62	
			V _{CC} = 6.0 V		53	
Propagation delay time, RESET to Q	t _{PHL2} <u>3/</u>	T _C = +25°C C _L = 50 pF ±10% See figure 4	V _{CC} = 2.0 V	9	225	ns
			V _{CC} = 4.5 V		45	
			V _{CC} = 6.0 V		38	
		T _C = -55°C, +125°C C _L = 50 pF ±10% See figure 4	V _{CC} = 2.0 V	10, 11	340	ns
			V _{CC} = 4.5 V		68	
			V _{CC} = 6.0 V		58	

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Test conditions <u>1/</u> -55°C ≤ T _C ≤ +125°C unless otherwise specified	Group A subgroups	Limits		Unit
				Min	Max	
Propagation delay time, ENABLE T to RIPPLE CARRY OUT	t _{PHL3} , t _{PLH3} <u>3/</u>	T _C = +25°C C _L = 50 pF ±10% See figure 4	V _{CC} = 2.0 V		195	ns
					39	
					33	
		T _C = -55°C, +125°C C _L = 50 pF ±10% See figure 4	V _{CC} = 2.0 V	10, 11	295	ns
					59	
					50	
Propagation delay time, CLOCK to RIPPLE CARRY OUT	t _{PHL4} , t _{PLH4} <u>3/</u>	T _C = +25°C C _L = 50 pF ±10% See figure 4	V _{CC} = 2.0 V	9	215	ns
					43	
					37	
		T _C = -55°C, +125°C C _L = 50 pF ±10% See figure 4	V _{CC} = 2.0 V	10, 11	325	ns
					65	
					55	
Propagation delay time, RESET to RIPPLE CARRY OUT	t _{PHL5} <u>3/</u>	T _C = +25°C C _L = 50 pF ±10% See figure 4	V _{CC} = 2.0 V	9	220	ns
					44	
					37	
		T _C = -55°C, +125°C C _L = 50 pF ±10% See figure 4	V _{CC} = 2.0 V	10, 11	330	ns
					66	
					56	
Transition time	t _{TLH} t _{THL} <u>4/</u>	T _C = +25°C C _L = 50 pF ±10% See figure 4	V _{CC} = 2.0 V	9	75	ns
					15	
					13	
		T _C = -55°C, +125°C C _L = 50 pF ±10% See figure 4	V _{CC} = 2.0 V	10, 11	110	ns
					22	
					19	

1/ For a power supply of 5 V ±10%, the worst case output voltages (V_{OH} and V_{OL}) occur for HC at 4.5 V. Thus, the 4.5 V values should be used when designing with this supply. Worst cases V_{IH} and V_{IL} occur at V_{CC} = 5.5 V and 4.5 V respectively. (The V_{IH} value at 5.5 V is 3.85 V.) The worst case leakage currents (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage, so the 6.0 V values should be used. Power dissipation capacitance (C_{PD}), typically 45 pF per latch, determines the no load dynamic power consumption, P_D = (C_{PD} V_{CC}² f) + (I_{CC} V_{CC}), and the no load dynamic current consumption, I_S = C_{PD} V_{CC} f + I_{CC}.

2/ V_{IH} and V_{IL} tests are not required and shall be applied as forcing functions for the V_{OH} or V_{OL} tests.

3/ AC testing at V_{CC} = 2.0 V and V_{CC} = 6.0 V shall be guaranteed, if not tested, to the specified limits.

4/ Transition time (t_{TLH}, t_{THL}), if not tested, shall be guaranteed to the specified limits in table I.

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Device type	01	
Case Outline	E, F	2
Terminal Number	Terminal Symbol	Terminal Symbol
1	RESET	NC
2	CLOCK	RESET
3	P0	CLOCK
4	P1	P0
5	P2	P1
6	P3	NC
7	ENABLE P	P2
8	GND	P3
9	LOAD	ENABLE P
10	ENABLE T	GND
11	Q3	NC
12	Q2	LOAD
13	Q1	ENABLE T
14	Q0	Q3
15	RIPPLE CARRY OUT	Q2
16	V _{CC}	NC
17	- - -	Q1
18	- - -	Q0
19	- - -	RIPPLE CARRY OUT
20	- - -	V _{CC}

NC = No internal connection

FIGURE 1. Terminal connections.

INPUTS					OUTPUTS
CLEAR	CLOCK	LOAD	ENABLE P	ENABLE T	Q
L	X	X	X	X	REST
H	↑	L	X	X	LOAD RESET DATA
H	↑	H	H	H	COUNT
H	X	H	L	X	NO COUNT
H	X	H	X	L	NO COUNT

H = High voltage level.

L = Low voltage level.

X = Irrelevant.

↑ = CLOCK transition from low-to-high level.

FIGURE 2. Truth table.

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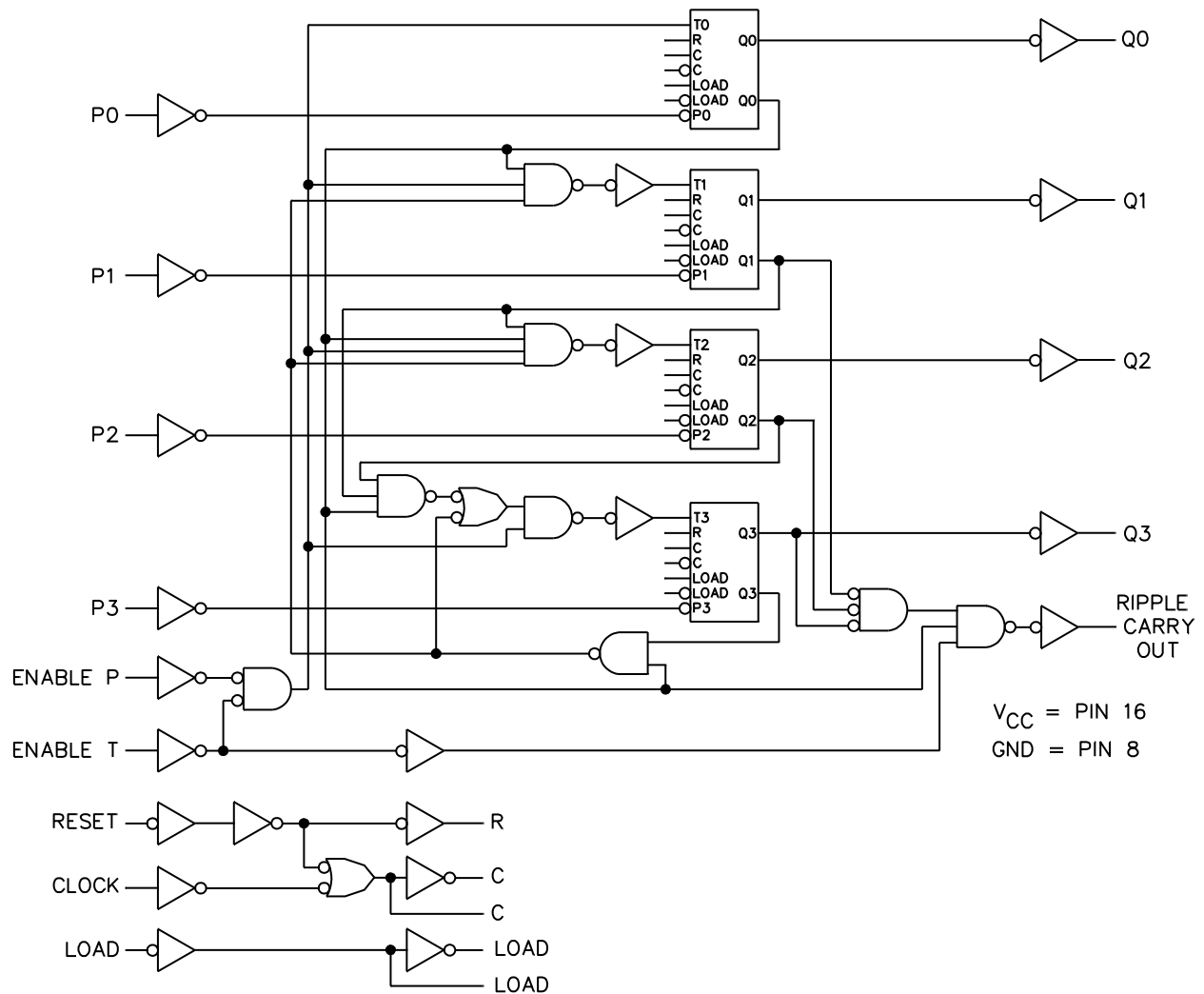


FIGURE 3. Logic diagram.

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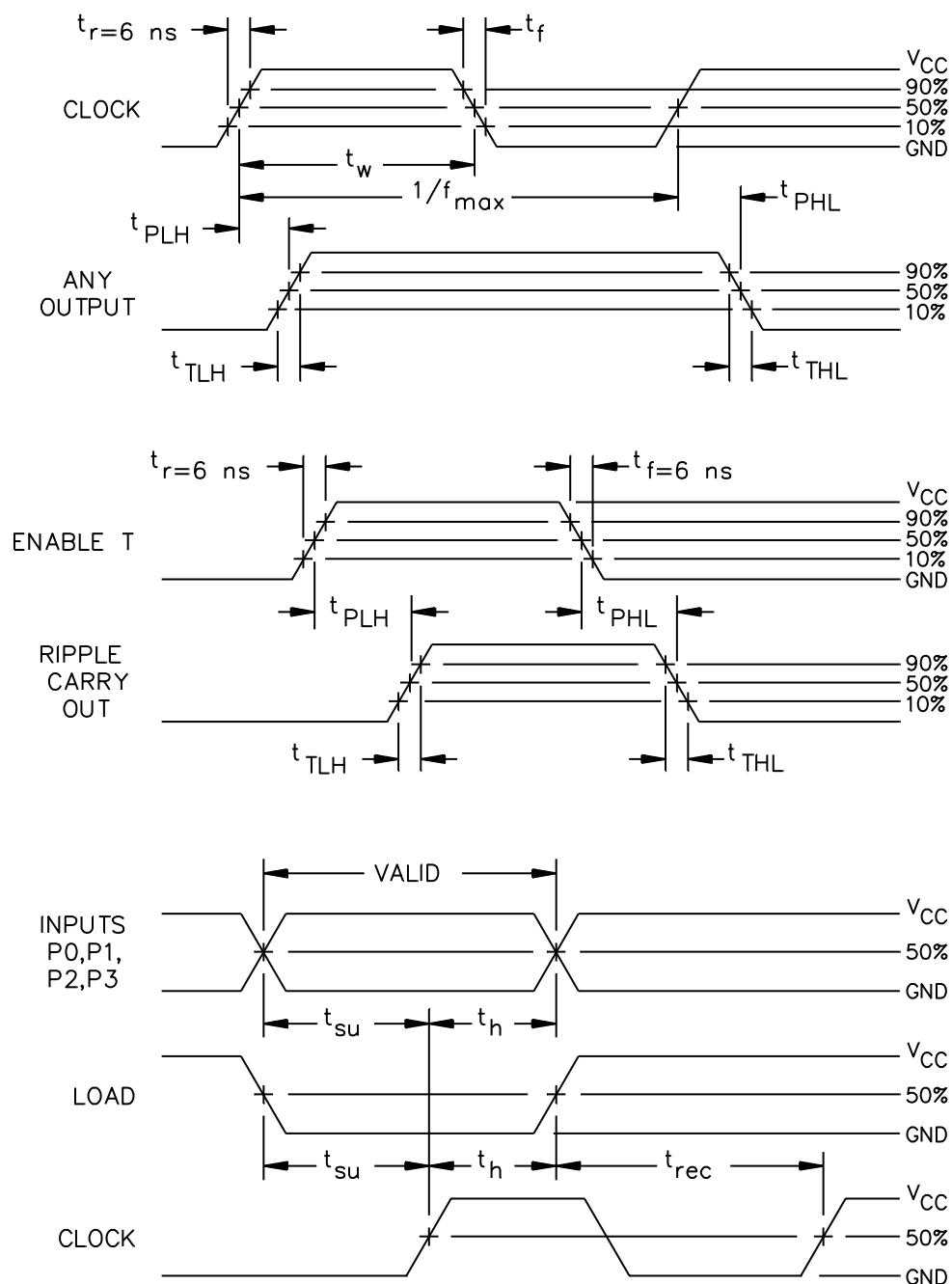


FIGURE 4. Switching waveforms.

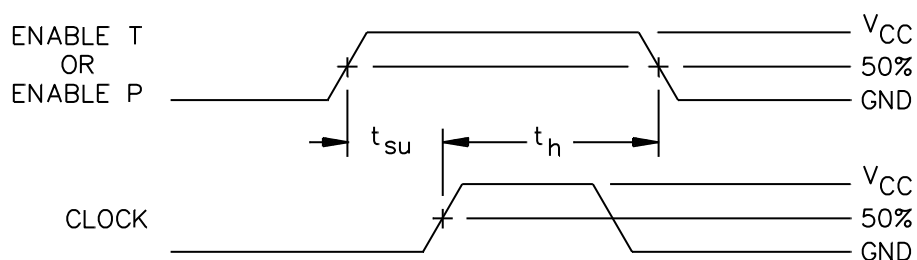
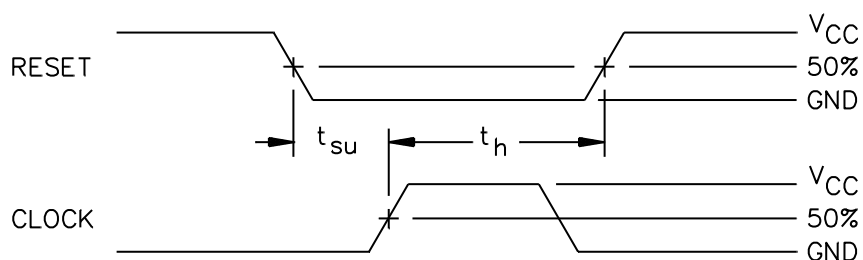
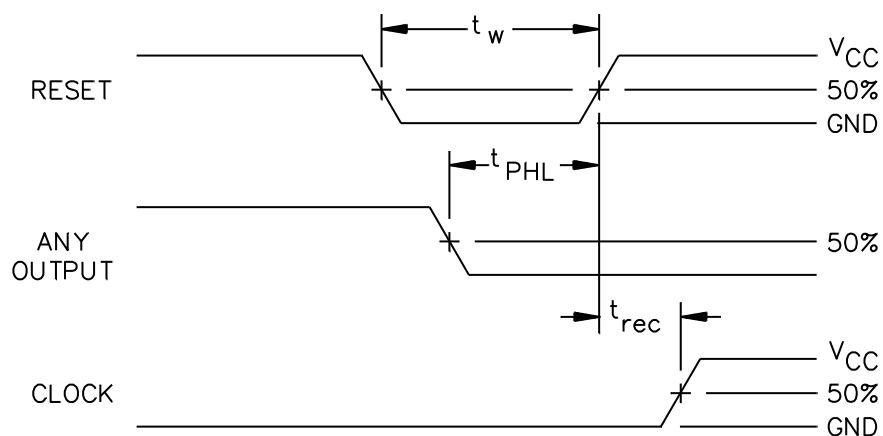
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NOTES:

1. $C_L = 50$ pF minimum or equivalent (includes probe and test fixture capacitance).
2. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1$ MHz, $Z_O = 50\Omega$, $t_r = 6.0$ ns, $t_f = 6.0$ ns.
3. The outputs are measured one at a time with one input transition per measurement.
4. Timing parameters shall be tested at a minimum input frequency of 1 MHz.

FIGURE 4. Switching waveforms - Continued.

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4. VERIFICATION

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.

(2) $T_A = +125^{\circ}\text{C}$, minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)
Interim electrical parameters (method 5004)	- -
Final electrical test parameters (method 5004)	1*, 2, 9
Group A test requirements (method 5005)	1, 2, 3, 7, 9, 10, 11**
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

* PDA applies to subgroup 1.

** Subgroups 10 and 11, if not tested, shall be guaranteed to the specified limits in table I.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

a. Tests shall be as specified in table II herein.

b. Subgroups 5, 6, and 8 in table I, method 5005 of MIL-STD-883 shall be omitted.

c. Subgroup 4 (C_{IN} measurement) shall be measured only for the initial test and after process or design changes which may affect input capacitance. Generic test data may be used to satisfy the subgroup 4 requirements.

d. Subgroups 7 tests shall be sufficient to verify the truth table in figure 2 herein.

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4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.
 - (2) $T_A = +125^{\circ}\text{C}$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.

6.4 Record of users. Military and industrial users shall inform DLA Land and Maritime when a system application requires configuration control and the applicable SMD to that system. DLA Land and Maritime will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DLA Land and Maritime-VA, telephone (614) 692-8108.

6.5 Comments. Comments on this drawing should be directed to DLA Land and Maritime-VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0540.

6.6 Approved sources of supply. Approved sources of supply are listed in MIL-HDBK-103 and QML-38535. The vendors listed in MIL-HDBK-103 and QML-38535 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DLA Land and Maritime-VA.

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STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 19-04-30

Approved sources of supply for SMD 5962-86824 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DLA Land and Maritime-VA. This information bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535. DLA Land and Maritime maintains an online database of all current sources of supply at: <https://landandmaritimeapps.dla.mil/programs/smcr/>

Standard Microcircuit Drawing PIN <u>1/</u>	Vendor CAGE number	Vendor similar PIN <u>2/</u>
5962-86824012A	3V146	54HC160/B2A
5962-8682401EA	3V146	54HC160/BEA
5962-8682401FA	3V146	54HC160/BFA

1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.

2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE
number

Vendor name
and address

3V146

Rochester Electronics Inc.
16 Malcolm Hoyt Drive
Newburyport, MA 01950

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in the information bulletin.